L Number	Hits	Search Text	DB	Time stamp
1	2	6090937[pn]	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/18 16:12
2	2	6096273[pn]	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/18 16:12
3	2	6221583[pn]	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/18 16:43
4	28714	(sulfur or sulfide or disulfide or phosphonate) near10 (bond or linkage)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/18 16:44
5	577084	(metal$5 or gold) near10 (surface or chip)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/18 16:46
6	50490	monolayer or sam	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/18 16:46
7	1194040	electrode	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/18 16:46
8	217	((sulfur or sulfide or disulfide or phosphonate) near10 (bond or linkage)) same ((metal$5 or gold) near10 (surface or chip))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/18 16:46
9	42	(((sulfur or sulfide or disulfide or phosphonate) near10 (bond or linkage)) same ((metal$5 or gold) near10 (surface or chip))) same ((monolayer or sam) or electrode)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/18 16:57
10	24734	sam or (self near10 assembl$3 near10 monolayer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/18 16:57
11	41	(sam or (self near10 assembl$3 near10 monolayer)) near10 disulfide	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/01/18;16:57